MODEL NO. : TM027CDH08



ISSUED DAT	E: <u>20</u>	<u>10-07-23</u>	
VERSION	: <u>Ve</u>	r 1.0	
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Customer :		_	
Approved by			Notes
SHANGHAI TIANMA Confirm	ed :		
Prepared by	Check	ed by	Approved by

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# **Record of Revision**

Rev	Issued Date	Description	Editor
1.0	2010-07-23	Preliminary Specification Release	Huiwang



# 1 General Specifications

	Feature	Spec
	Size	2.7 inch
	Resolution	320RGBx240
	Interface	8-bit RGB /8-bit Dummy RGB /CCIR656/601
	Color Depth	16.7M
	Technology Type	a-Si
Display Spec	Pixel pitch (mm)	0.16875x0.16875
	Pixel Configuration	R.G.B. Delta
	Display Mode	TM With Normally White
	Surface Treatment(Up Polarizer)	HC
	Viewing Direction	12 o'clock
	Gray Scale Inversion Direction	6 o'clock
	LCM (W x H x D) (mm)	63.50x46.60x1.94
Mashaniasi	Active Area(mm)	54.0040.50
Mechanical Characteristics	With /Without TSP	Without TSP
	Weight (g)	TBD
	LED Numbers	2 LEDs
Electronic	Driver IC	ILI8961

Note 1: Viewing direction for best image quality is different from TFT definition, there is a 180 degree shift.

Note 2: Requirements on Environmental Protection: RoHS

Note 3: LCM weight tolerance: +/- 5%



# 2 Input/Output Terminals

### 2.1 TFT LCD Panel

Matching Connector:

No	Symbol	I/O	Description	Remark
1	VCOM	I	Panel common voltage	
2	GRB	I	Global reset pin, it should be connected to VDDIO in normal operation.	
3	CS	I	Data input Enable.	
4	SDA	1	SPI data input	
5	SCL	1	SPI clock input	
6	HSYNC	I	Horizontal sync input	
7	VSYNC	1	Vertical sync input	
8	DCLK	1	Data clock input	
9	D7	I	Data input; MSB	
10	D6	I	Data input	
11	D5	I	Data input	
12	D4	I	Data input	
13	D3	I	Data input	
14	D2	I	Data input	
15	D1	I	Data input	
16	D0	1	Data input; LSB	
17	GND	Р	Power ground	
18	GND	Р	Power ground	
19	VDD	Р	Power supply for charge pump circuit.	
20	VDDIO	Р	Power supply for digital interface	
21	DVDD	С	Power setting capacitor connecting pin.	
22	V1	С	Power setting capacitor connecting pin.	
23	V2	С	Power setting capacitor connecting pin.	_
24	V3	С	Power setting capacitor connecting pin.	
25	V4	С	Power setting capacitor connecting pin.	
26	VDD2	С	Power setting capacitor connecting pin.	

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27	V5	С	Power setting capacitor connecting pin.	
28	V6	С	Power setting capacitor connecting pin.	
29	VDD3	С	Power setting capacitor connecting pin.	
30	VDD5	С	Power setting capacitor connect pin	
31	V7	С	Power setting capacitor connect pin	
32	V8	Р	Power setting capacitor connect pin.	
33	VGH	0	Power setting capacitor connect pin.	
34	VGL	0	Power setting capacitor connect pin.	
35	AGND	С	Ground for analog circuits.	
36	FRP	0	Frame polarity output for panel VCOM.	
37	VCOMDC	0	VCOM DC output.	
38	VCAC	0	Power setting capacitor for VCOM AC.	
39	LED+	Р	LED power anode	
40	LED-	Р	LED power cathode	
41	VCOM	I	Panel common voltage	

Note2.1: I/O definition:

I--- Input; O---Output; P---Power/Ground; C---Capacitor; NC--- Not Connected

# 3 Absolute Maximum Ratings

### 3.1 Driving TFT LCD Panel

Ta = 25°C

Item	Symbol	Min	Max	Unit	Remark
Supply Voltage	VDD	-0.3	5.0	٧	
Input Signal Voltage	D0~D7,VCOM,GRB,CS,SDA,SCL, HSYNC, VSYNC,DCLK,VCOM	-0.3	VDDIO +0.3	٧	
Back Light Forward Current	I <sub>LED</sub>	-	30	mA	2 LEDs in series
Operating Temperature	T <sub>OPR</sub>	-20	70	${\mathbb C}$	
Storage Temperature	T <sub>STG</sub>	-30	80	$^{\circ}$	



### 4 Electrical Characteristics

### 4.1 Driving TFT LCD Panel

GND=0V, Ta=25°C

Item		Symbol	MIN	TYP	MAX	Unit	Remark
Supply Vol	tage	VDD	3.0	3.3	3.6	V	
	High	VIH	0.7xVDDIO	-	VDDIO	V	VDDIO = 2.7V~3.6V
Input Signal	Level	VIII	0.8xVDDIO	-	VDDIO	V	VDDIO = 1.65V~2.7V
Voltage	Low	VIL	GND	-	0.3xVDDIO	V	VDDIO = 2.7V~3.6V
	Level	VIL	GND	-	0.2xVDDIO	V	VDDIO = 1.65V~2.7V
Output Signal	High Level	VOH	VDDIO -0.4	-	VDDIO	V	VGH,VGL,FRP,
Voltage	Low Level	VOL	GND	-	0.4	V	VCOMDC, VCAC
(Panel+LSI) Power Consumption		Normal Mode	-	(16.0)	1	mA	CLK 27MHz
		-	-	-	-	-	
		Standby Mode	-	(120)	-	uA	

### 4.2 Driving Backlight

Ta=25°C

Item	Symbol	Min	Тур	Max	Unit	Remark
Forward Current	I <sub>F</sub>		25		mA	E
Forward Voltage	$V_{F}$		(6.4)		V	For one LED Note 1,2,3
Power Consumption	$W_{BL}$	-	128		mW	14010 1,2,0

Note 1: The figure below shows the connection of backlight LED.

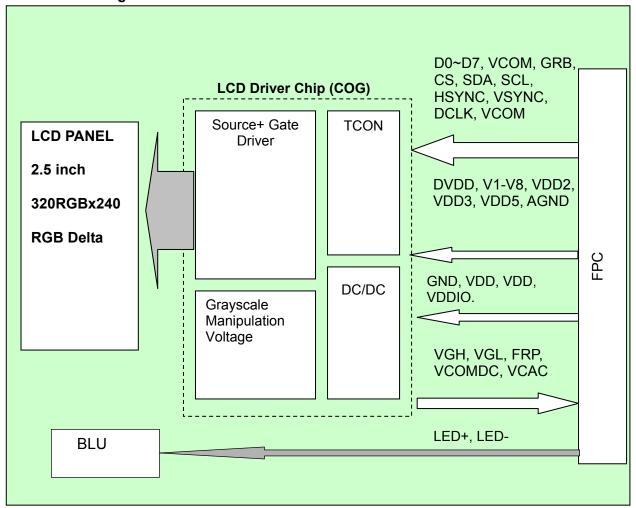


Note 2: One LED: I<sub>F</sub> =25mA; Two LED:VF=6.4V

Note 3: The life of LED: 20,000 hours



### 4.3 Block Diagram





# 5 Timing Chart

### 5.1 3-WIRE SERIAL CONTROL INTERFACE

### 5.2 3-WIRE REGISTER TABLE

Register	Do
Rooh   0   1/0   0   0   0   0   0   0   0   0   0	
R03h	
R04h 0 1/0 0 0 0 1 0 0 Narrow C656_EN IF_SEL NP_SEL LDIF (10) (10) (10)	
Ro4h 0 1/0 0 0 0 1 0 0 Narrow C656_EN IF_SEL NP_SEL LDIF (10) (10)	
	YDIR (1)
R05h 0 1/0 0 0 0 1 0 1 DRV_SET GRB PWM_SEL VGHL_EN PWM_	
Bosh 0 1/0 0 0 1 1 0 HBLK_EN FB_SEL VBLK	
P07b 0 1/0 0 0 1 1 1 1 1 HBLK	
R08h 0 1/0 0 0 1 0 0 DRV_SEL	×
PoPh 0 1/0 0 0 1 0 1 1 REGSEL V V V V V V V V V V V V V V V V V V V	×
ROCH 0 1/0 0 0 1 1 0 0 VST DE_EN CbCr DENP VSDP HSD	CLKINP
RODH 0 1/0 0 0 1 1 0 1 CONTRAST	(0)
(40h)	
(40h)	
ROFI   0   70   0   1   1   1   X   (40h)	
(40h)	
R11h 0 1/0 0 1 0 0 0 1 x	
H12h   0   1/0   0   1   0   0   1   0   0   1   0   (00)	
R16h 0 1/0 0 1 0 1 1 0 x x x x x GOP_EN x	x
R17h 0 1/0 0 1 0 1 1 1 1 x L016P_SEL x L008P_S (100)	
R18h 0 1/0 0 1 1 0 0 0 x L050P_SEL x L032P_S (101)	
R19h 0 1/0 0 1 1 0 0 1 x L096P_SEL x L072P_S (100)	EL
R1Ah 0 1/0 0 1 1 0 1 0 x L120P_SEL x L110P_S (101)	EL
R2Bh 0 1/0 1 0 1 0 1 1 x x X X X X X X X	STB (0)
R2Fh 0 1/0 1 0 1 1 1 1 x VGH_SEL CF_SEL LC_SEL (11) (0) (00)	SOPC (01)
P3Ch 0 1/0 1 1 1 1 0 0 GAMMA_EN L127P_SEL L000P_S	
NSSN 0 10 1 1 1 0 0 (0) (011)	
R3Dh   0   1/0   1   1   1   0   1   X   L127N_SEL   X   L000N_S (111)	EL
R3Eh 0 1/0 1 1 1 1 1 0 X L016N_SEL X L008N_S (100)	EL
R3Fh 0 1/0 1 1 1 1 1 X L050N_SEL X L032N_S (100)	EL
R40h 1 1/0 0 0 0 0 0 0 X L096N_SEL X L072N_S (011)	EL
R41h 1 1/0 0 0 0 0 0 1 X L120N_SEL X L110N_S (100)	EL
R55h 1 1/0 0 1 0 1 0 1 x INV_SEL DAT_INV x x x	х
R57h 1 1/0 0 1 0 1 1 1 VGHL_ENB x x x X X X X	х
	GL_SEL (10)



Note:

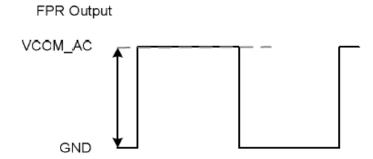
- 1. When RSTB is low, all registers reset to default values.
- 2. Serial commands are executed at next VSD signal.

### 5.3 3-WIRE REGISTER DESCRIPTION

VCAC (R00h[3:0]): VCOM voltage AC level seletion

D[3:0]				Low Voltage LC(V)	Normal Voltage LC1(V)	Normal Voltage LC 2(V)
0	0	0	0	3.6	4.0	5.0
0	0	0	1	3.7	4.1	5.1
0	0	1	0	3.8	4.2	5.2
0	0	1	1	3.9	4.3	5.3
0	1	0	0	4	4.4	5.4
0	1	0	1	4.1	4.5	5.5
0	1	1	0	4.2 (default)	4.6 (default)	5.6 (default)
0	1	1	1	4.3	4.7	5.7
1	0	0	0	4.4	4.8	5.8
1	0	0	1	4.5	4.9	5.9
1	0	1	0	4.6	5.0	6.0
1	0	1	1	4.7	5.1	6.1
1	1	Х	Х	4.8	5.2	6.2

\*Note: Please reference LC type to R2Fh[3:2] LC\_SEL



### C601\_EN (R00h[6]): CCIR601 interface control

D6	Function
0	Disable CCIR601. (default)
1	Enable CCIR601. (please refer to the table of R04H(IF_SEL) for detail descrption

### Y CbCr (R00h[7]): Y & CbCr exchange position (only valid for 8-bit input YUV640/YUV720)

	Under $R0C[4]$ CbCr = '0'	Under R0C [4] CbCr = '1'
D7 = '0'	Cb0 Y0 Cr0 Y1 Cb2 Y2 Cr2 Y3	Cr0 Y0 Cb0 Y1 Cr2 Y2 Cb2 Y3
(default)		



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D7 = '1'

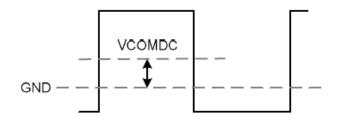
Y0 Cb0 Y1 Cr0 Y2 Cb2 Y3 C	Cr2
---------------------------	-----

Parameter Data								
Register	D7	D7 D6 D5 D4 D3 D2 D1 D0						
R01h	VCDCEN	v	VCDC					
110111	(1)	^	(21h)					

### VCDC (R01h[5:0]): VCOM voltage DC level selection (20mV/step)

D[5:0]	Low Voltage LC(V)	Normal Voltage LC 1 & 2(V)
00h	0.24	0.5
:	:	:
21h	0.90 (default)	1.16 (default)
:	:	:
3Fh	1.5	1.76

VCOMDC couple by FRP



### VCDCEN (R01h[7]): VCOM DC enables control

D7	VCDCEN Fuction
0	VCOM DC function disabled. The VCOMDC pin is connected to GND.
1	VCOM DC function enabled. The VCOMDC voltage follows VCOM DC setting. (default)

Pogietor	Parameter Data								
Register	D7 D6 D5 D4 D3 D2 D1 D0						D0		
R03h	Brightness (40h)								

### Brightness (R03h[7:0]): RGB brightness level control

D[7:0]	Brightness Offset
00h	Dark. (-64)
40h	Center. (0). (default)
FFh	Bright. (+191)

Setting accuracy 1bit/step



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Dogiotor	Parameter Data								
Register	D7	D6	D5	D4	D3	D2	D1	D0	
R04h	Narrow	C656_EN	IF_SEL		NP_S	SEL	LDIR	YDIR	
NO4II	(0)	(0)	(00)		(10)		(1)	(1)	

### YDIR(R04h[0]): Source driver output direction selection

	YDIR Function
0	Shift from right to left. Y1 ←Y2←←Y959←Y960
1	Shift from left to right. Y1 → Y2 → → Y959 → Y960 (default)

### LDIR(R04h[1]): Gate driver output direction selection

	LDIR Function
0	Shift from down to up. L1 ←L2←←L239←L240
1	Shift from up to down. L1→L2→→L239→L240 (default)

### NP\_SEL[1:0] (R04h[3:2]): NTSC/PAL input mode selection.

D[3	:2]	NTSC/PAL Mode
0	0	PAL.
0	1	NTSC
1	X	Auto detection. (default)

### IF\_SEL[1:0] (R04h[5:4]): Input data format selection.

R00h[6]	D6	D[5	5:4]	Input Timing format
0	0	0	0	8-bit RGB. (default)
0	0	0	1	8-bit Dummy RGB 320 x 240
0	0	1	Х	8-bit Dummy RGB 360 x 240
0	1	X	Х	CCIR656
1	1	0	Х	YUV640
1	1	1	0	YUV720

### C656\_EN(R04h[6]): CCIR656/CCIR601 or RGB/RGB-Dummy input interface selection.

	• • •
D6	Data format
0	RGB input. (default)
1	CCIR656/YUV640/YUV720 input

### Narrow(R04h[7]): Normal / Narrow display selection

D7	Function
0	Normal display. (default)
1	Narrow display.





Narrow = 0

Narrow = 1

Int \*Not valid for parallel and serial 8-bit RGB interface.

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### TM027CDH08 V1.0

Pogietor	Parameter Data							
Register	D7	D6	D5	D4	D3	D2	D1	D0
R05h	DRV_SET	GRB	PWM_SEL			VGHL_EN	PWM_EN	v
HUSII	(0)	(1)	(0 <del>11</del> )			(1)	(1)	X

### PWM\_EN(R05h[1]): Back light power converter control.

D1	PWM_EN Funciton
0	The back light power converter is off.
1	The back light power converter is controlled by STB's power on/off sequence. (default)

### VGHL\_EN(R05h[2]): VGH/VGL charge pump control

D2	VGHL_EN Funciton
0	VGH/VGL charge pump is always off.VGL will set to GND level.
1	VGH/VGL charge pump is controlled by STB's power on/off sequence. (default)

### PWM\_SEL(R05h[5:3]): PWM duty cycle selection for back light power convert

	D[5:3]		PWM duty cycle
0	0	0	55%
0	0	1	60%
0	1	0	65%
0	1	1	70% (default)
1	0	0	75%
1	0	1	80%
1	1	0	85%
1	1	1	90%

### GRB(R05h[6]): Global reset

D6	GRB Function
0	Reset all registers to default value.
1	Normal operation. (default)

### DRV\_SET(R05h[7]): DRV signal frequency selection

D7	DRV operation frequency
0	High Frequency. (default)
1	Low Frequency.



### TM027CDH08 V1.0

Pogletor	Parameter Data							
Register	D7	D6	D5	D4	D3	D2	D1	D0
R06h	HBLK_EN	BLK_EN FB_SEL		VBLK				
HUUII	(0)	(0	00)			(15h)		

### VBLK[4:0]( R06h[4:0]): Vertical blanking setting for 8-bit RGB, 8-bit Dummy RGB & CCIR656

For 8-bit RGB, 8-bit Dummy RGB, YUV640, YUV720, CCIR656 NTSC mode, and Parallel RGB input mode.

D[4:0]	VBLK Function	Unit
00h~03h	3.	
04h	4.	н
15h	21. (default)	"
1Fh	31.	

For 8-bit Dummy RGB, YUV640, YUV720, CCIR656 PAL mode (Vertical Blanking + 3)

D[4:0]	VBLK Function	Unit
00h	3.	
04h	7.	— н
15h	24. (default)	П
1Fh	34.	

### FB SEL[1:0] (R06h[6:5]): adjustable for DC-DC feedback threshold voltage

D[6:5]	Feedback Threshold Voltage
00	0.6 V. (default)
01	0.75V.
10	0.45V.
11	0.3V.

### HBLK\_EN (R06h[7]): Horizontal blanking function enable control

D[7]	HBLK EN Function
0	Disable(default)
1	Enable

Pogletor	Parameter Data								
Register	D7	D6	D5	D4	D3	D2	D1	D0	
R07h	HBLK (46h)								
NO/II									

### HBLK (R07h[7:0]): Horizontal blanking setting

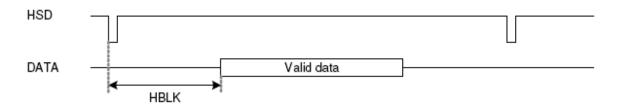
HBLK_EN	D7~D0	HBLK	Unit	NTSC/PAL Mode	
X	32h~45h	50~69			
X	46h	70	CLKIN(*)	8-bit RGB	
X	47h∼FFh	71~255			
X	X	241	CLKIN(*)	8-bit Dummy RGB	
0	XXh	240	CLKIN(*)		
1	00h~03h	3	CLKIN(*)	YUV640, YUV720	
1	04h~FFh	4~255	CLKIN()		
0	X	61			
1	00h~03h	3	CLKIN(*)	Parallel RGB	
	04h~3Fh	4~63	, ,		

<sup>\*</sup>The frequency of CLKIN is different under different input timing.

'X': don't care



### TM027CDH08 V1.0



Pogletor	Parameter Data								
Register	D7	D6	D5	D4	D3	D2	D1	D0	
R08h	DRV_9 (00	SEL )	х	×	x	х	х	х	

### DRV\_SEL(R08h[7:6]): Backlight driving capability setting

D7	D6	DRV_SEL capability
0	0	Normal capability. (default)
0	1	2 times the Normal capability.
1	0	3 times the Normal capability.
1	1	4times the Normal capability.

	Register	Parameter Data								
l	negistei	D7	D6	<b>D</b> 5	D4	D3	D2	D1	D0	
	R0Bh	REGSEL (0)	х	х	х	х	x	х	х	

### REGSEL (R0Bh[7]): MTP function control register

D7	REGSEL Function
0	VCOMDC Output Voltage is read from MTP memory. (default)
1	VCOMDC Output Voltage is controlled by the register R01h_VCDC[5:0].



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	Register	Parameter Data									
1	negistei	D7	D6	D5	D4	D3	D2	D1	D0		
	R0Ch	VS <sup>-</sup> (00		DE_EN (0)	CbCr (0)	DENP (0)	VSDP (1)	HSDP (1)	CLKINP (0)		

### CLKINP (R0Ch[0]): CLKIN polarity selection

	CLKINP Function
0	Latch data at CLKIN rising edge. (default)
1	Latch data at CLKIN falling edge

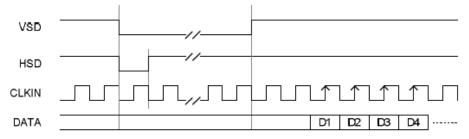
### HSDP (R0Ch[1]): HSD polarity selection

D1	HSDP Function
0	Positive polarity.
1	Negative polarity. (default)

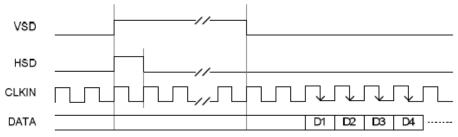
### VSDP (R0Ch[2]): VSD polarity selection

D2	VSDP Function
0	Positive polarity.
1	Negative polarity. (default)

### HSDP = 1, VSDP = 1, CLKINP = 0



### HSDP = Q, VSDP = Q, CLKINP = 1.



### DENP (R0Ch[3]): DEN polarity selection

-	
D3	DENP Function
0	Positive polarity (default)
1	Negative polarity



### CbCr (R0Ch[4]): Cb & Cr exchange position (valid for CCIR656 and YUV640/YUV720)

D4	CbCr Function
0	Cb→Y→Cr. (default)
1	Cr→Y→Cb.

### DE\_EN(R0Ch[5]) : DE mode selection

D5	DE_EN Function
0	HV mode selected. (default)
1	DE mode selected.

<sup>\*</sup> DE\_EN only controls the HV and DE mode at 8-bit RGB, 8-bit Dummy RGB and Parallel Mode.

### VST(R0Ch[7:6]): Vertical start time of odd/even frame

8-bit RGB / 8-bit Dummy RGB NTSC / 8-bit Dummy RGB PAL(\*)

Parallel RGB input mode (PSEL= "Low")

VS	VST VBLK			
D7	D6	ODD/EVEN	Unit	
X	0	21/21. (default)	H(Line)	
X	1	21/20.	TI(LITIE)	

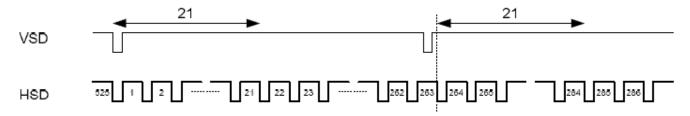
### CCIR656/YUV640/YUV720 NTSC/PAL(\*\*)

V	ST	VBLK	Unit	
D7 D6		ODD/EVEN	Offic	
0	0	21/21. (default)		
0	1	21/22	∐/Lipo\	
1	0	22/21	H(Line)	
1	1	22/22		

- (\*) The typical value of VBLK of 8-bit Dummy RGB PAL (24 H) is different from 8-bit RGB/8-bit Dummy RGB NTSC(21H).
- (\*\*) The typical value of VBLK of CCIR656 PAL (24 H) is different from CCIR656 NTSC (21H).

Note: V-Blanking must be adjusted base on the input data.

### For example:





### TM027CDH08 V1.0

Register	Parameter Data							
	D7	D6	D5	D4	D3	D2	D1	D0
R0Dh	CONTRAST							
RODE				(4	l0h)			

CONTRAST(R0Dh[7:0]): RGB contrast level setting, the gain changes(1/64)/bit.

### Gain formula=0.75+(R CONT/256)

Contrast Gain
0
1 (default)
3.984

Pogletor				Parame	eter Data			
Register	D7	D6	D5	D4	D3	D2	D1	D0
ROEh	х				R_CONT (40h)			

R-CONT(R0Eh[6:0]): Red sub-pixel contrast level setting, the gain changes (1/256)/bit.

### Gain formula=0.75+(R\_CONT/256)

D[6:0]	R Contrast Gain
00h	0.75
40h	1 (default)
7Fh	1.246

Register	Parameter Data								
	D7	D6	D5	D4	D3	D2	D1	D0	
R0Fh	х		R_BRIGHT (40h)						

R-BRIGHT(R0Fh[6:0]): Red sub-pixel brightness level setting, setting accuracy: 1 step/bit.

D[6:0]	R Brightness Offset
00h	darker (-64)
40h	center (0) (default)
7Fh	brighter (+63)



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Pogletor	Parameter Data							
Register	D7 D6 D5 D4 D3 D2 D1						D0	
R12h				TR	MEN			
NIZII				(	00)			

### TRMEN (R12h): VCOM DC Trim Function Control Register

VCOMDC Trim function control register, Write the follow command sequentially to enable the VCOMDC trim function.

Adjust VCDC level:

Set TRMEN[7:0] = 00h and set REGSEL=1(R0Bh=80h)

Write proper VCDC[5:0] value using 3-wire command.

Programming the VCDC value into MTP memory:

Set VPP\_MTP = 7.5V with external power supply for programming operation. (Requirement)

Set TRMEN[7:0] as following sequence: A0h → 5Fh → EEh →00h

REGSEL will be clear to 0 after the programming procedure.

### Procedure-1 Set RoGSoL = 1, Please make sure VCDCoN=1

Procedure-2
Update VCDC vaule

# Procedure-3 VCOMDC trim state please follow Note

Procedure-4
Handware clear RoGSoL=0,
check RoGSoL =0 by 3-wire
read check VCOMDC value

# TRMoN≠A0h TRMoN=A0h TRMoN=A0h TRMoN=5Fh S1 TRMoN=ooh S2 TRMoN=00h Programming VCOM\_DC Value

### Note:

- The Trim Block can be writing for only "3" times
- 2. After finishing TRMEN command do not power off within 1 second.
- 3. Trim command exceed the limitation may cause the VCOMDC output unknown value.

The 4. The CLKIN input frequency should be 26MHz ~ 30MHz.

CS ten

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### TM027CDH08 V1.0

Pogletor		Parameter Data							
Register	D7	D6	D5	D4	D3	D2	D1	D0	
R16h	х	х	х	×	х	GOP_EN (1)	х	х	

### GON\_EN (R16h): Select auto or manual gamma setting

D2	Gamma op enable Function
0	Manual set gamma by R17h~R1Ah.
1	Auto set to gamma2.2. (default)

Pogletor				Parame				
Register	D7	D6	D5	D4	D3	D2	D1	D0
R17h	х	L016P_SEL (101)			х	L008P_SEL (100)		
R18h	х		L50P_ŚEL (101)			L032P_SEL (100)		
R19h	х	L096P_SEL (100)			х			
R1Ah	х		L120P_SEL (101)		х	L110P_SEL (100)		

Registers: R17h~R1Ah

L008P\_SEL: Gamma op output selection to level VP8; L016P\_SEL: Gamma op output selection to level VP16; L032P\_SEL: Gamma op output selection to level VP32;

L050P\_SEL: Gamma op output selection to level VP50;

L072P\_SEL: Gamma op output selection to level VP72;

L096P\_SEL: Gamma op output selection to level VP96;

L110P\_SEL: Gamma op output selection to level VP110;

L120P\_SEL: Gamma op output selection to level VP120;

Reference point	000	001	010	011	100	101	110	111
L008P(100)	-4△V	-3△V	-2△V	-△V	Default	+△V	+2△V	+3△V
L016P(101)	-5△V	-4△V	-3△V	-2△V	-△V	Default	+△V	+2△V
L032P(100)	-4△V	-3△V	-2△V	-△V	Default	+△V	+2△V	+3△V
L050P(101)	-5△V	-4△V	-3△V	-2△V	-△V	Default	+△V	+2△V
L072P(011)	-3△V	-2△V	-△V	Default	+△V	+2△V	+3△V	+4△V
L096P(100)	-4△V	-3△V	-2△V	-△V	Default	+△V	+2△V	+3 \\ \
L110P(100)	-4△V	-3△V	-2△V	-△V	Default	+△V	+2△V	+3 △ V
L120P(101)	-5△V	-4△V	-3△V	-2△V	-△V	Default	+△V	+2△V

Note:(1) For Low Voltage LC application, △V= 25mV ∘

(2) For Normal Voltage LC application, △V= 40mV ∘



### TM027CDH08 V1.0

Pogletor		Parameter Data						
Register	D7	D6	D5	D4	D3	D2	D1	D0
R2Bh	х	х	х	х	х	х	х	STB (0)

### STB(R2Bh[0]): Standby (Power saving) mode control

D0	STB Function
0	Standby Mode. (default)
1	Normal operation.

Register	Parameter Data							
negistei	D7	D6	D5	D4	D3	D2	D1	D0
R2Fh	х	VGH_SEL (11)		CF_SEL (0)	LC_SEL (00)		SP (0	

### SOPC (R2Fh[1:0]): Source output driving capability selection

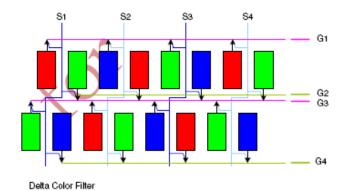
D1	D0	Source Driver Capability
0	0	-25%.
0	1	Normal. (default)
1	0	+25%
1	1	+50%

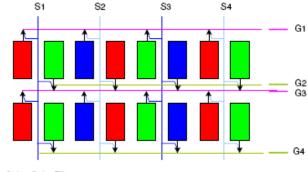
### LC\_SEL (R2Fh[3:2]): Source output driving capability selection

D3	D2	LC type selection
0	0	Low Voltage LC (default)
0	1	-
1	0	Normal Voltage LC 2
1	1	Normal Voltage LC 1

### CF\_SEL(R2Fh[4]): Color filter selection

D4	Function
0	Delta color filter. (default)
1	Stripe color filter.





Stripe Color Filter



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VGH\_SEL(R2Fh[6:5]): VGH voltage level selection

D6	<b>D</b> 5	VGH Voltage
0	0	VGL  + 2V.
0	1	VGL  + 3V.
1	0	VGL  + 4V.
1	1	VGL + 5V. (default)

Dogletor		Parameter Data										
Register	D7	D6	D5	D4	D3	D2	D1	D0				
R3Ch	GAMMA_EN (0)		L127P_SEL (011)		Х	L	000P_SEL (100)					

GAMMA\_EN: Gamma Reference Point Control Enable

D7	GAMMA_EN Function
0	VN reference point control setting follow VP (default)
1	VP / VN Reference point control independently

L127P\_SEL: Gamma op output selection to level VP127; L000P\_SEL: Gamma op output selection to level VP000;

Reference point	000	001	010	011	100	101	110	111
L000P(100)	-4△V	-3∆V	-2△V	-1△V	Default	+1△V	+2△V	+3△V
L127P(011)	-3△V	-2△V	-1△V	Default	+1△V	+2△V	+3△V	+4△V

Note:(1) For Low Voltage LC application, △V= 25mV ∘

(2) For Normal Voltage LC application, △V= 40mV ∘

Register				Param	eter Data				
negister	D7	D6	D5	D4	D3	D2	D1	D0	
R3Dh	Х		L127N_SEI (011)	-	Х	L	000N_SEL (111)		
R3Eh	Х		L016N_SEI (101)	-	Х	L008N_SEL (100)			
R3Fh	Х		L050N_SEI (101)	-	Х	L032N_SEL (100)			
R40h	Х		L096N_SEI (100)	-	X	L072N_SEL (011)			
R41h	Х		L120N_SEI (101)	-	Х	L110N_SEL (100)			

L127N\_SEL: Gamma op output selection to level VN127;

L000N\_SEL: Gamma op output selection to level VN000;

L016N SEL: Gamma op output selection to level VN16;

L008N\_SEL: Gamma op output selection to level VN8;

L050N\_SEL: Gamma op output selection to level VN50;

L032N SEL: Gamma op output selection to level VN32;

L096N\_SEL: Gamma op output selection to level VN96;







L072N\_SEL: Gamma op output selection to level VN72; L120N\_SEL: Gamma op output selection to level VN120; L110N\_SEL: Gamma op output selection to level VN110;

Reference point	000	001	010	011	100	101	110	111
L000N(000)	+7△V	+6△V	+5△V	+4△V	+3△V	+2△V	+1△V	Default
L008N(100)	-4△V	-3△V	-2△V	-△V	Default	+△V	+2△V	+3△V
L016N(101)	-5∆V	-4△V	-3△V	-2△V	-△V	Default	+△V	+2△V
L032N(100)	-4△V	-3△V	-2△V	-△V	Default	+△V	+2△V	+3△V
L050N(101)	-5∆V	-4△V	-3△V	-2△V	-△V	Default	+△V	+2∆V
L072N(011)	-3△V	-2△V	-△V	Default	+△V	+2△V	+3△V	+4△V
L096N(100)	-4△V	-3△V	-2△V	-△V	Default	+△V	+2△V	+3△V
L110N(100)	-4△V	-3∆V	-2△V	-△V	Default	+△V	+2△V	+3△V
L120N(101)	-5∆V	-4△V	-3△V	-2△V	-△V	Default	+△V	+2△V

Note:(1) For Low Voltage LC application, △V= 25mV ∘

(2) For Normal Voltage LC application, △V= 40mV ∘

Register				Parame	eter Data			
	D7	D6	D5	D4	D3	D2	D1	D0
R55h	х	INV_SEL (0)	DAT_INV (0)	х	х	х	х	х

### DAT\_INV (R55h[5]): Source output Inversion control

D5	DAT_INV Function
0	Data output normal. (default)
1	Data output inversion.

### INV\_SEL (R55h[6]): Inversion selection

I	D6	INV_SEL Function
I	0	One line inversion. (default)
I	1	Column inversion.

Register		Parameter Data										
	D7	D6	D5	D4	D3	D2	D1	D0				
R57h	VGHL_ENB (0)	х	х	х	х	х	х	х				

### VGHL\_ENB (R57h[7]): VGH/VGL charge pump control

D7	VGHL_ENB Function
0	VGH/VGL charge pump enable. ( <b>default</b> )
1	VGH/VGL charge pump enable, for external VGH/VGL application.

<sup>\*</sup>Note: don't apply external power to VGH and VGL pad when VGHL\_EN=0 and VGHL\_ENB=0.



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Pogletor				Parameter Data											
Register	D7	D6	D5	D4	D3	D2	D1	D0							
R5Ah	х	х	х	х	х	х	VGL_ (1	SEL 0)							

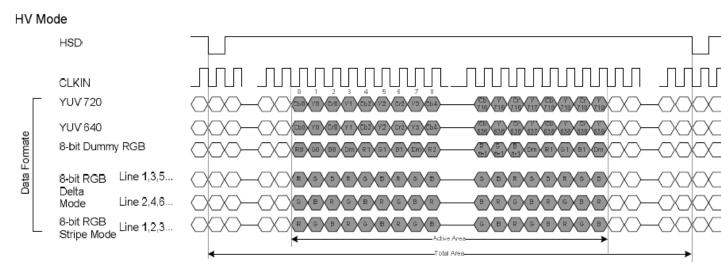
### VGL\_SEL (R5Ah[1:0]): VGL voltage level selection

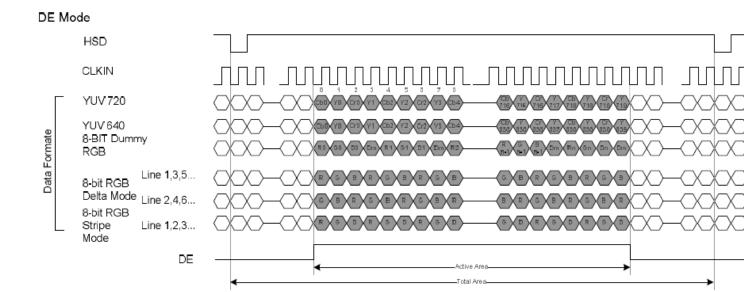
D1	D0	VGL Voltage
0	0	-8V
0	1	-9V
1	0	-10V (default)
1	1	-11V



### 5.4 DATA INPUT FORMAT

### Serial 8-bit RGB / 8-bit Dummy RGB / YUV Mode Data format

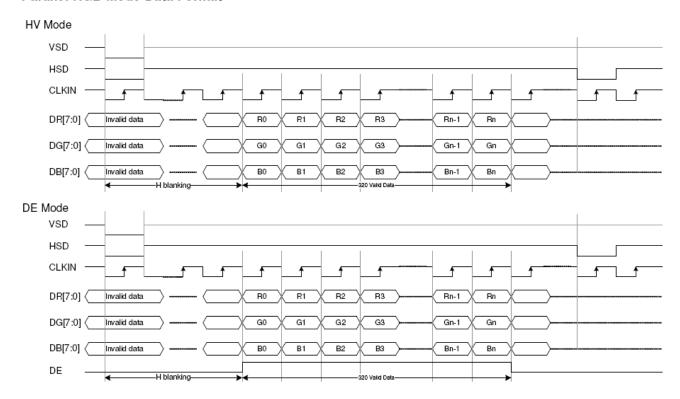




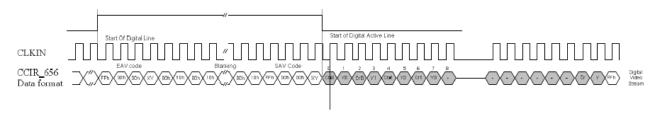




### Parallel RGB Mode Data Format



### CCIR\_656 Mode Data format



- FF 00 00 XY signals are involoved with HSD, VSD and Field.
- XY encode following bits:

F = field select

V = indicate vertical blanking

H = 1, if EAV else 0 for SAV

P3-P0 = protection bits:

 $P3 = V \oplus H P2 = F \oplus H P1 = F \oplus V P0 = F \oplus V \oplus H \oplus :$ Represents the exclusive-OR function.

	XY								
D7(MSB) D6 D5 D4 D3 D2 D1 D0							D0		
1	1 F V H P3 P2 P1 P0								

- Control is provided through "End of Video" (EAV) and "Start of Video" (SAV) timing references.
- Horizontal blanking section cosists of repeating pattern 80 10 80 10



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### Data Active Area

Input Format	Format Standard	CLKIN(MHz)	Н	Total AREA	Active AREA	
	CCIR_601	fCLKIN = 27	1	1716	1440	
YUV	CCIR_656	ICLNIN = 27	1	1728		
	CCIR_601	fCLKIN = 24.54	1	1560	1280	
8-bit Dummy	NTSC/PAL	fCLKIN = 27	4	1560	1440	
RGB	NISOFAL	fCLKIN = 24.54		1560	1280	
8-bit RGB	NTSC	fCLKIN = 27	1	1716	960	
24bit RGB	320RGB x 240	fCLKIN =6.4	1	390	320 (RGB)	

(Unit:CLKIN)

### CCIR656/YUV640/YUV720 to RGB Conversion Formula

 $R_n = 1.164^* [(Y_{2n\text{-}1} + Y_{2n})/2 \text{-} 16] + 1.596^* (Cr_n\text{-} 128)$ 

 $G_n = 1.164^*[(Y_{2n\text{-}1}\text{-}1+Y_{2n})/2\text{-}16] - 0.813^*(Cr_n\text{-}128) - 0.392^*(Cb_n\text{-}128)$ 

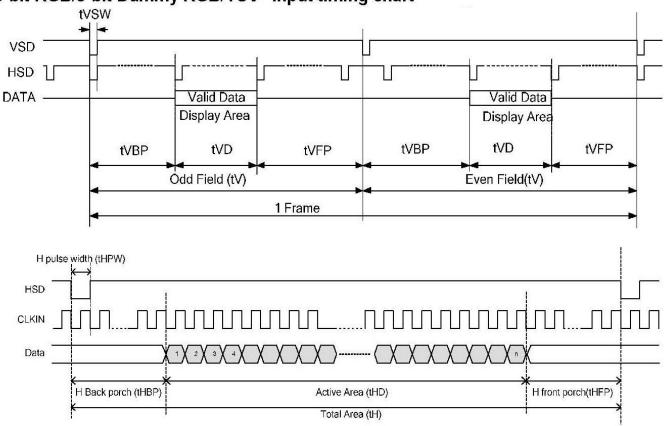
 $B_n = 1.164^*[(Y_{2n-1}+Y_{2n})/2-16] + 2.017^*(Cb_{n-128})$ 

Where Y: 16~235 Cr: 16~240 Cb: 16~240



### 5.5 INPUT TIMING FORMAT

### 8-bit RGB/8-bit Dummy RGB/YUV Input timing chart



# 8-bit RGB input timing

Parameter		Cumbal		Interlace		Unit
raiailletei		Symbol	Min.	Тур.	Max.	OIIIL
CLKIN frequ	iency	fCLKIN	13.5	27	27.19	MHz
HSD period		tH	1024	1716	1728	CLKIN
HSD display	period	tHD		960		CLKIN
HSD back p	orch	tHBP	50	70	255	CLKIN
HSD front p	orch	tHFP	14	686	718	CLKIN
HSD pulse width		tHSW	1	1	tHBP-1	CLKIN
VSD period	time	tV	242.5	262.5	450.5	Н
Vertical disp	lay area	tVD		240		Н
VSD	Odd field	tVBP	3	21	31	Н
back porch	Even field	LVDP	3.5	21.5	31.5	П
VSD	Odd field	A/CD	1.5	1.5	179.5	111
front porch	Even field	tVFP	1	1	179	Н
VSD pulse v	VSD pulse width		1 CLKIN	1CLKIN	6H	
1 Frame			485	525	901	Н



### 8-bit Dummy RGB input timing

8-bit Dummy RGB (320 mode/NTSC/24.535Mhz) input timing

		1 1		lusta ula a a		1
Parameter		Symbol		Interlace	<u> </u>	Unit
1 drameter		Oyboi	Min.	Тур.	Max.	O III.
CLKIN frequ	iency	fCLKIN	20.45	24.535	30	MHz
HSD period		tH	1306	1560	1907	CLKIN
HSD display	period	tHD		1280		CLKIN
HSD back p		tHBP	3	241	255	CLKIN
HSD front p	HSD front porch		25	39	372	CLKIN
HSD pulse	width	tHSW	1	1	200	CLKIN
VSD period	time	tV	242.5	262.5	450.5	H
Vertical disp	lay area	tVD	240			Н
VSD	Odd field	tVBP	3	21	31	11
back porch	Even field	T LABE	3.5	21.5	31.5	Н
VSD	Odd field	tVFP	1.5	1.5	179.5	Lii
front porch	Even field	TIVEE	1	1	179	Н Н
VSD pulse v	VSD pulse width		1	1	200	CLKIN
1 Frame	·		485	525	901	Н

8-bit Dummy RGB (320 mode/PAL/24.375Mhz) input timing

Parameter		Symbol		Interlace		Unit
Parameter	raiailletei		Min.	Тур.	Max.	Onit
CLKIN frequ	lency	fCLKIN	20.45	24.375	30	MHz
HSD period		tH	1306	1560	1920	CLKIN
HSD display	period	tHD		1280		CLKIN
HSD back p	orch	tHBP	3	241	255	CLKIN
HSD front porch		tHFP	25	39	385	CLKIN
HSD pulse width		tHSW	1	1	200	CLKIN
VSD period	time	tV	292.5	312.5	450.5	Н
Vertical disp	lay area	tVD	288			Н
VSD	Odd field	tVBP	3	23	34	11
back porch	Even field	J MADE [	3.5	23.5	34.5	- H
VSD	Odd field	W/ED	1.5	1.5	128.5	10
front porch	Even field	tVFP	1	1	128	1 H
VSD pulse v	width	tVSW	1	1	200	CLKIN
1 Frame			585	625	901	Н

8-bit Dummy RGB (360 mode/NTSC/27Mhz) input timing

Parameter		Cump had		Interlace		Limit
raiametei		Symbol	Min.	Тур.	Max.	Unit
CLKIN frequ	uency	fCLKIN	23	27	30	MHz
HSD period		tH	1466	1716	1907	CLKIN
HSD display	period	tHD		1440		CLKIN
HSD back p		tHBP	3	241	255	CLKIN
HSD front porch		tHFP	25	35	212	CLKIN
HSD pulse width		tHSW	1	1	200	CLKIN
VSD period	time	tV	242.5	262.5	450.5	Н
Vertical disp	olay area	tVD	240			Н
VSD	Odd field	1 VDD	3	21	31	
back porch	Even field	tVBP	3.5	21.5	31.5	H
VSD	Odd field	N/ED	1.5	1.5	179.5	1.7
front porch Even field		tVFP	1	1	179	H
VSD pulse width		tVSW	1	1	200	CLKIN
1 Frame			485	525	901	Н



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8-bit Dummy RGB (360 mode/PAL/27Mhz) input timing

Parameter		Symbol		Interlace		Unit
raiailletei		Symbol	Min.	Тур.	Max.	John
CLKIN frequ	iency	fCLKIN	23	27	30	MHz
HSD period		tH	1466	1728	1920	CLKIN
HSD display	period	tHD		1440		CLKIN
HSD back p	orch	tHBP	3	241	255	CLKIN
HSD front p	HSD front porch		25	47	225	CLKIN
HSD pulse v	width	tHSW	1	1	200	CLKIN
VSD period	time	tV	292.5	312.5	450.5	Н
Vertical disp	lay area	tVD		288		
VSD	Odd field	tVBP	3	23	34	Н
back porch	Even field	J MAD I	3.5	23.5	34.5	
VSD	Odd field	tVFP	1.5	1.5	128.5	1.1
Front porch Even field			1	1	128	H
VSD pulse v	VSD pulse width		1	1	200	CLKIN
1 Frame			585	625	901	Н

YUV720 and YUV640 input timing YUV 720 mode/NTSC input timing

Parameter		Symbol		Interlace		1144
Parameter	raiametei		Min.	Тур.	Max.	Unit
CLKIN frequ	uency	fCLKIN	153	27	=	MHz
HSD period		tH		1716	<u>14</u> 20	CLKIN
HSD display	/ period	tHD		1440		CLKIN
HSD back p	orch	tHBP	#1	240	-	CLKIN
HSD front p	HSD front porch		-	36	-	CLKIN
HSD pulse	HSD pulse width		-	1		CLKIN
VSD period	time	tV	-	262.5	-	Н
Vertical disp	lay area	tVD	240			Н
VSD	Odd field	tVBP	3	21	<u>a</u> 1	1.1
back porch	Even field	J LABA L	29	21.5	40	H
VSD	Odd field	#\/ED	48	1.5	-	111
front porch Even field		tVFP	<b>H</b> 1	1	-	H
VSD pulse width		tVSW	-	1	8	CLKIN
1 Frame				525	-	Н

YUV 720 mode/PAL input timing

Parameter		Symbol		Interlace		Unit
Parameter	raiailletei		Min.	Тур.	Max.	Unit
CLKIN frequ	iency	fCLKIN	<b></b>	27	=	MHz
HSD period		tH	- 8	1728	9	CLKIN
HSD display	period	tHD		1440		CLKIN
HSD back p	orch	tHBP	= 1	240	=	CLKIN
HSD front porch		tHFP	<b>*</b>	48		CLKIN
HSD pulse width		tHSW	-	1	8	CLKIN
VSD period	time	tV	-	312.5	-	Н
Vertical disp	olay area	tVD	288			H
VSD	Odd field	W/DD	- 8	24	9	10
back porch	Even field	tVBP	40	24.5	#	Н
VSD	Odd field	tVFP	48	0.5	=	111
front porch	Even field		<b>±</b> (	0	H	H
VSD pulse width		tVSW	-	1	-	CLKIN
1 Frame			<b>=</b> 10	625	- 5	Н



### TM027CDH08 V1.0

YUV 640 mode/NTSC input timing

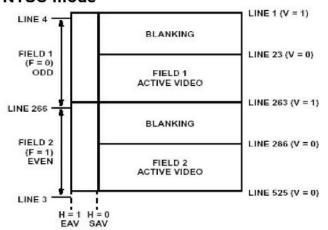
Parameter		Symbol		Interlace		Unit
Parameter		Syllibol	Min.	Тур.	Max.	OIIIL
CLKIN frequ	iency	fCLKIN	-	24.535		MHz
HSD period		tH	-	1560	-	CLKIN
HSD display	/ period	tHD		1280		CLKIN
HSD back p	orch	tHBP	<u>u</u>	240		CLKIN
HSD front p	orch	tHFP	-	40	2	CLKIN
HSD pulse v	HSD pulse width		<u> </u>	1	=	CLKIN
VSD period	time	tV	-	262.5	4	Н
Vertical disp	olay area	tVD	240			H
VSD	Odd field	tVBP	-	21	-	Н
back porch	Even field	] IVEF [	<u>=</u>	21.5	2	
VSD	Odd field	tVFP	<u> </u>	1.5	<u> </u>	11
front porch Even field			=	1	_	H
VSD pulse v	VSD pulse width		-	1	=	CLKIN
1 Frame			-	525	-	Н

YUV 640 mode/PAL input timing

Parameter		Symbol		Interlace		Unit	
raiailletei		Syllibol	Min.	Тур.	Max.	- Ollit	
CLKIN frequ	iency	fCLKIN	-	24.375	-	MHz	
HSD period		tH	7.0	1560		CLKIN	
HSD display	period	tHD		1280		CLKIN	
HSD back p	orch	tHBP	4	240	=	CLKIN	
HSD front porch		tHFP	-	40	-	CLKIN	
HSD pulse width		tHSW	÷	1	=	CLKIN	
VSD period	time	tV	+	312.5	÷	H	
Vertical disp	lay area	tVD		288		Н	
VSD	Odd field	tVBP	5	24	-	13	
back porch	Even field	J MADE [		24.5		- H	
VSD	Odd field	AVED.	4	0.5	<u>10</u> 4	17	
front porch	Even field	tVFP	=	0	2	-  H	
VSD pulse width		tVSW	-	1	=	CLKIN	
1 Frame			-	625	-	Н	



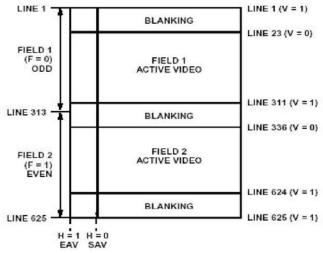
# CCIR656 input timing NTSC mode



LINE NUMBER	F	v	H (EAV)	H (SAV)
1-3	1	1	1	0
4-22	0	1.	1	0
23-262	0	0	-1	0
263-265	0	1	1	-0
266-285	1	1	1	0
286-525	1	0	1	0

	F	Ή	٧
1	EVEN Field	EAV	BLANKING
0	ODD Field	SAV	ACTIVE VIDEO

### PAL mode



	F	H	٧
1	EVEN Field	EAV	BLANKING
0	ODD Field	SAV	ACTIVE VIDEO

LINE NUMBER	F	v	H (EAV)	H (SAV)
1-22	0	1	1	0
23-310	0	0	1	0
311-312	0	1	1	0
313-335	1	.1	1	0
336-623	1	0	1	0
624-625	-1.	1	1	0



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### 5.6 AC ELECTRICAL CHARACTERISTICS

(VDD=3.0~3.6V, VDDIO=AVDD=VDD, AGND=GND=0V, TA=25°C)

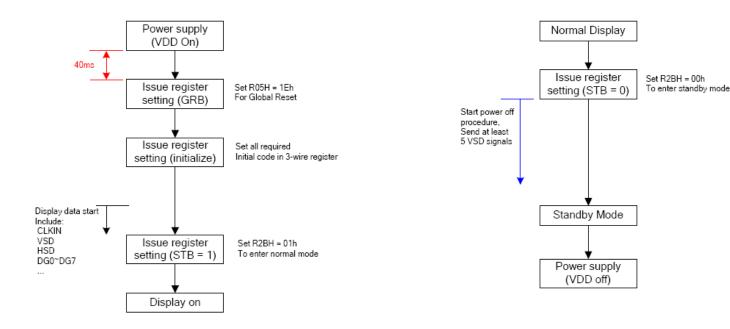
Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
HSD period time	Th	60	63.56	67	us	
VSD setup time	Tvst	12	-	-	ns	
VSD hold time	Tvhd	12	4	-	ns	
HSD setup time	Thst	12	-	-	ns	
HSD hold time	Thhd	12	-	-	ns	
Data setup time	Tdsu	12	-	-	ns	DB0~DB7 to
Data hold time	Tdhd	12	-		ns	DB0~DB7 to
Time that VSD to 1st Gate output	Tstv	0	21	31	Н	@ 8-bit RGB, 8-bit Dummy RGB NTSC, Delay by VBLK setting.
Time that CCIR_V to 1st Gate output	Tstv	0	22	31	Н	@ CCIR656 NTSC, Delay by VBLK setting.
Time that CCIR_V to 1st Gate output	Tstv	3	24	34	Н	@ 8-bit Dummy RGB & CCIR656 PAL, Delay by VBLK setting.
Source output setting time (*1)	Tst	=	-	8	us	R= <mark>25K ohm</mark> , C= 30 pF 10% → 90% final.
Gate output setting time (*1)	Tstg	1	0.5	1	us	R= 3K ohm , C= 25 pF 10% → 90% final.
VCOM setting time (*1)	Tst,vcom		-	9	us	R= 200 ohm , C= 5 nF 10% → 90% final.
Time that HSD width	Twh	1	-	-	CLKIN	

### Ps. (\*1) Test Condition:

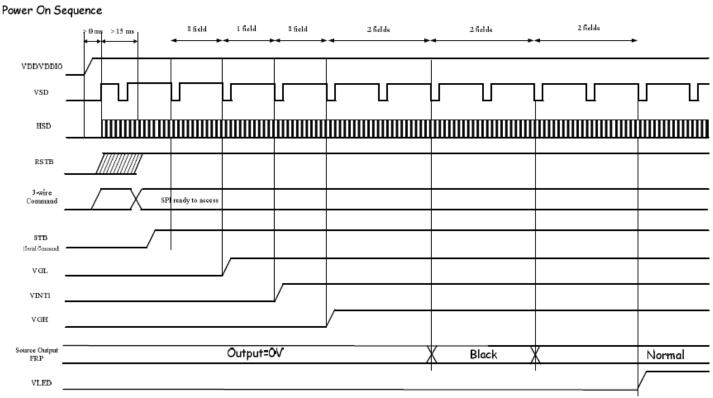
When the tested signal is changed from Vo, min to Vo, max, the time that is from the start of change to the time that the swing voltage at point B is less than +/- 20 mV is called the setting time of the tested signal.

# 6 Power On/Off Sequence

### 6.1 INITIALIZE FLOW CHART



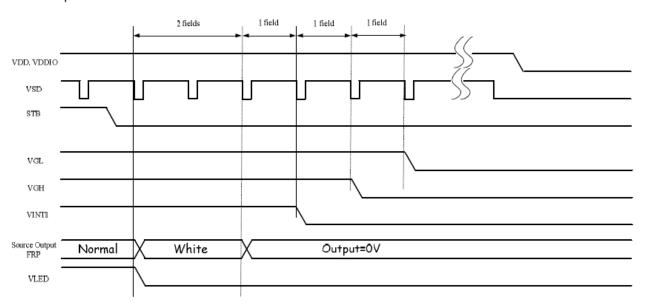
### 6.2 POWER ON SEQUENCE



Note: 1. The RSTB should keep low until VDDIO was stable, and set to high before SPI command start 2. After STB set to 1, it takes 9 VSD pulse for power on operation



Power Off Sequence









## Optical Characteristics

### 7.1 Optical Specification

Ta=25°C

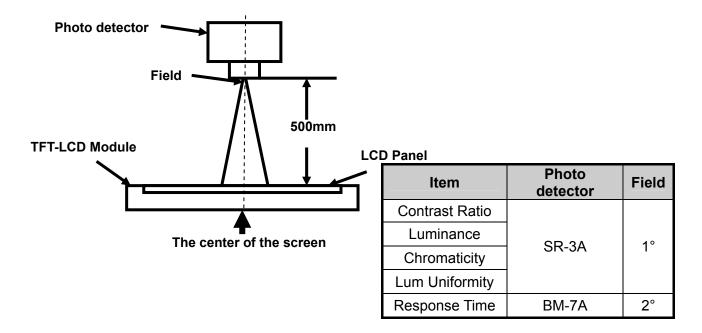
Item		Symbol	Condition	Min	Тур	Max	Unit	Remark
View Angles		θТ	CR≧10	50	60	-	Dograd	Nata O
		θВ		60	70	-		
View Angles		θL	OIX≦ IU	60	70	-	Degree	Note 2
		θR		60	70	-		
Contrast Ratio	)	CR	θ=()°	400	500	ı	Note1 Note3	
Response Tim	10	Ton	25℃		30	45	ms	Note1
iveshouse tiili	ie –	Toff	25 (	_	30	40	1115	Note4
	White x y		0.251	0.301	0.351			
		у	Backlight is on	0.280	0.330	0.380	- 1	Note5, Note1
	Red	х		0.546	0.596	0.646		
Chromaticity		у		0.293	0.343	0.393		
Chilomaticity	Green	х		0.293	0.343	0.393		
		у		0.483	0.533	0.583		
		х		0.098	0.148	0.198		
	Diue	Blue		0.069	0.119	0.169		
Uniformity		U	-	75	80	-	%	Note1 Note6
NTSC		-	-	-	40	-	%	Note 5
Luminance		L	-	220	270	-	cd/m <sup>2</sup>	Note1 Note7

### **Test Conditions:**

- 1.  $V_F$ =3.2V,  $I_F$ =25mA (Backlight Current), the ambient temperature is 25  $^{\circ}$ C.
- 2. The test systems refer to Note 1 and Note 2.

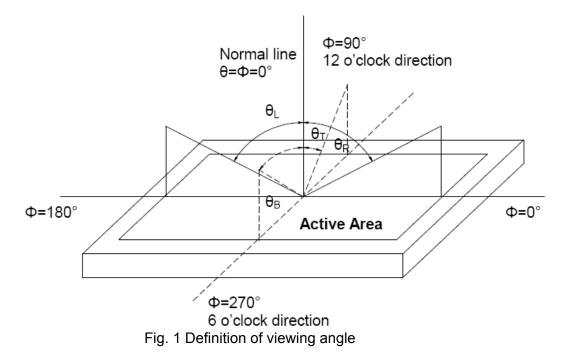
Note 1: Definition of optical measurement system.

The optical characteristics should be measured in dark room. After 5 minutes operation, the optical properties are measured at the center point of the LCD screen. All input terminals LCD panel must be ground when measuring the center area of the panel.



Note 2: Definition of viewing angle range and measurement system.

viewing angle is measured at the center point of the LCD by CONOSCOPE(ergo-80).



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Note 3: Definition of contrast ratio

Contrast ratio (CR) = Luminance measured when LCD is on the "White" state

Luminance measured when LCD is on the "Black" state

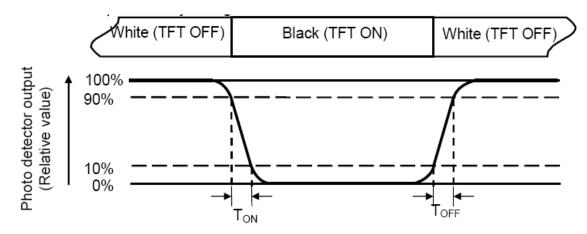
"White state ": The state is that the LCD should driven by Vwhite.

"Black state": The state is that the LCD should driven by Vblack.

Vwhite: To be determined Vblack: To be determined.

### Note 4: Definition of Response time

The response time is defined as the LCD optical switching time interval between "White" state and "Black" state. Rise time (TON) is the time between photo detector output intensity changed from 90% to 10%. And fall time (TOFF) is the time between photo detector output intensity changed from 10% to 90%.



Note 5: Definition of color chromaticity (CIE1931)

Color coordinates measured at center point of LCD.

### Note 6: Definition of Luminance Uniformity

Active area is divided into 9 measuring areas (Refer Fig. 2). Every measuring point is placed at the center of each measuring area.

Luminance Uniformity(U) = Lmin / Lmax

L----- Active area length W----- Active area width

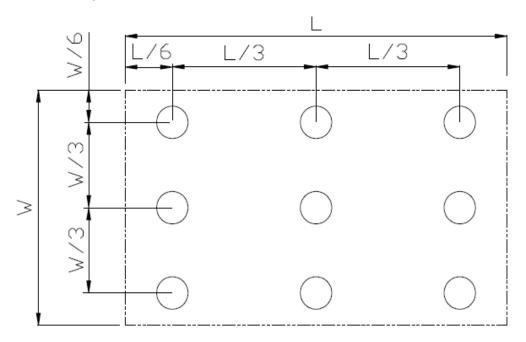


Fig. 2 Definition of uniformity

Lmax: The measured maximum luminance of all measurement position.

Lmin: The measured minimum luminance of all measurement position.

### Note 7: Definition of Luminance:

Measure the luminance of white state at center point.



# 8 Environmental / Reliability Tests

No	Test Item	Condition	Remark
1	High Temperature Operation	Ts=+70℃, 240hrs	Note1 IEC60068-2-2,GB2423.2—89
	Low Temperature Operation		IEC60068-2-1 GB2423.1—89
	High Temperature Storage		IEC60068-2-2, GB2423.2—89
4	Low Temperature Storage		IEC60068-2-1 GB2423.1—89
5	High Temperature & High Humidity Storage	Ta=+60℃, 90% RH 240 hours	Note2 IEC60068-2-3, GB/T2423.3—2006
6	Thermal Shock (Non-operation)	-30°C 30 min~+70°C 30 min, Change time:5min, 20 Cycles	Start with cold temperature, End with high temperature, IEC60068-2-14,GB2423.22—87
7	Electro Static Discharge (Operation)	C=150pF, R=330 $\Omega$ ,5points/panel Air: $\pm$ 8KV, 5times; Contact: $\pm$ 4KV, 5 times; (Environment: $15^{\circ}C \sim 35^{\circ}C$ , $30\% \sim 60\%$ , $86$ Kpa $\sim 106$ Kpa)	IEC61000-4-2 GB/T17626.2—1998
8	Vibration (Non-operation)	Frequency range:10~55Hz, Stroke:1.5mm Sweep:10Hz~55Hz~10Hz 2 hours for each direction of X.Y.Z. (6 hours for total) (Package condition)	IEC60068-2-6 GB/T2423.10—1995
9	Shock (Non-operation)	60G 6ms, ±X,±Y,±Z 3times, for each direction	IEC60068-2-27 GB/T2423.5—1995
10	Package Drop Test	Height:80 cm, 1 corner, 3 edges, 6 surfaces	IEC60068-2-32 GB/T2423.8—1995

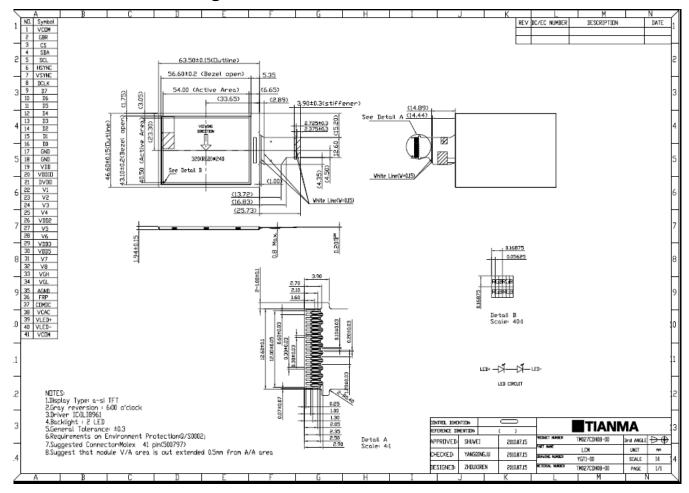
Note1: Ts is the temperature of panel's surface.

Note2: Ta is the ambient temperature of sample.



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# 9 Mechanical Drawing

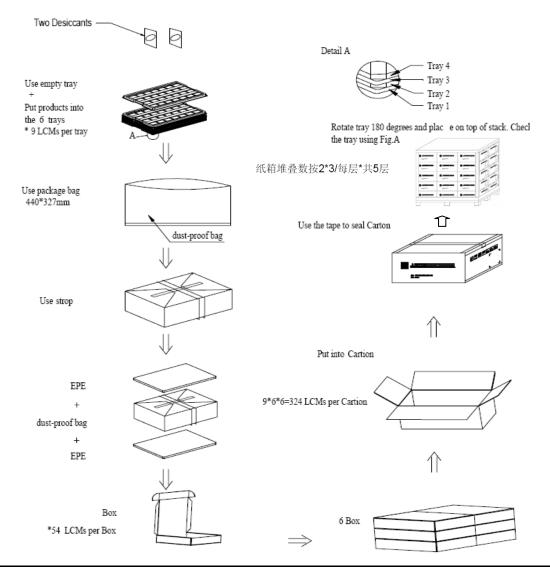




# 10 Packing Drawing

### 10.1 Packaging Material Table

No	Item	Model (Material)	Dimensions(mm)	Unit Weight(Kg)	Quantity	Remark
1	LCM module	TM027CDH02	63.5x46.6x1.94	TBD	432	
2	Tray	PET(Transmit)	315×247×10.6	TBD	54	Anti-static
3	EPE	EPE	315×247×5	0.009	6	
4	Desiccant	Desiccant	45x35	0.002	12	
5	Anti-static bag	PE	700x545	0.055	1	
6	Box	Corrugated Paper	345x260x70	0.227	6	
7	Carton	Corrugated Paper	544x365x250	1.01	1	
8	Total weight(Kg)		TBD	1		



### 11 Precautions For Use of LCD Modules

- 11.1 Handling Precautions
- 11.1.1 The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.
- 11.1.2 If the display panel is damaged and the liquid crystal substance inside it leaks out, be sure not to get any in your mouth, if the substance comes into contact with your skin or clothes, promptly wash it off using soap and water.
- 11.1.3 Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
- 11.1.4 The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.
- 11.1.5 If the display surface is contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If still not completely clear, moisten cloth with one of the following solvents:
  - Isopropyl alcohol
  - Ethyl alcohol

Solvents other than those mentioned above may damage the polarizer. Especially, do not use the following:

- Water
- Ketone
- Aromatic solvents
- 11.1.6 Do not attempt to disassemble the LCD Module.
- 11.1.7 If the logic circuit power is off, do not apply the input signals.
- 11.1.8 To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
- 11.1.8.1 Be sure to ground the body when handling the LCD Modules.
- 11.1.8.2 Tools required for assembly, such as soldering irons, must be properly ground.
- 11.1.8.3 To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.
- 11.1.8.4 The LCD Module is coated with a film to protect the display surface. Be care when peeling off this protective film since static electricity may be generated.
- 11.2 Storage precautions
- 11.2.1 When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps.
- 11.2.2 The LCD modules should be stored under the storage temperature range. If the LCD modules will be stored for a long time, the recommend condition is:

Temperature: 0°C ~ 40°C Relatively humidity: ≤80%

- 11.2.3 The LCD modules should be stored in the room without acid, alkali and harmful gas.
- 11.3 Transportation Precautions:

The LCD modules should be no falling and violent shocking during transportation, and also should avoid excessive press, water, damp and sunshine.